

4 Ω Dual SPST Switches

DESCRIPTION

The DG2537, DG2538, and DG2539 are low voltage, precision dual SPST switches that can be operated in a single supply or in a dual supply configuration power supply with low power dissipation. The DG2537, DG2538 and DG2539 can switch both analog and digital signals within the power supply rail, and conduct well in both directions.

Fabricated with advance submicron CMOS process, these switches provide high precision low and flat ON resistance, low leakage current, low parasitic capacitance, and low charge injection.

The DG2537, DG2538 and DG2539 contain two independent Single Pole Single Throw (SPST) switches. Switch-1 and switch-2 are normally open for the DG2537 and normally closed for the DG2538. For the DG2539, switch-1 is normally open and switch-2 is normally closed with a Break-Before-Make switching timing.

The DG2537, DG2538 and DG2539 are the ideal switches for use in low voltage instruments and healthcare devices, fitting the circuits of low voltage ADC and DAC, analog front end gain control, and signal path control.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device termination.

As a further sign of Vishay Siliconix's commitment, the DG2537, DG2538 and D2539 are fully RoHS compliant and halogen-free.

FEATURES

- **Halogen-free According to IEC 61249-2-21 Definition**
- Low and flat switch on resistance, 2.5 Ω /typ
- Low leakage and parasitic capacitance
- 366 MHz, - 3 dB bandwidth
- Latch-up current > 300 mA (JESD78)
- Over voltage tolerant TTL/CMOS compatible
- **Compliant to RoHS Directive 2002/95/EC**

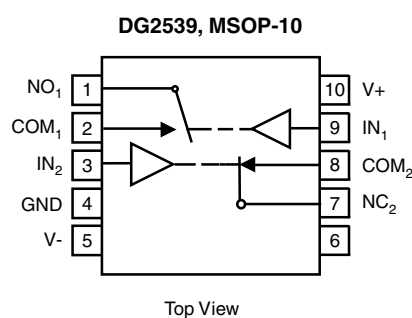
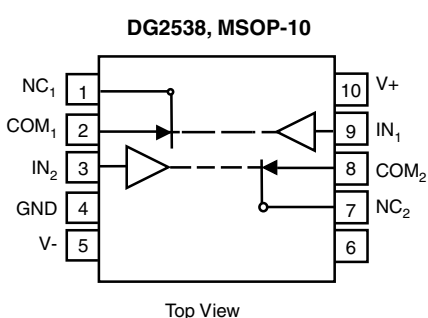
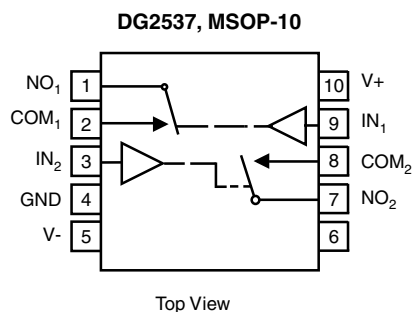


RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Healthcare and medical devices
- Test instruments
- Portable meters
- Data acquisitions
- Control and automation
- PDAs and modems
- Communication systems
- Audio, video systems
- Mechanical reed relay replacement

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



TRUTH TABLE (DG2537, DG2538)			
Logic	DG2537	DG2538	Switches
0	0	1	Off
1	1	0	On

TRUTH TABLE (DG2539)		
Logic	Switch-1	Switch-2
0	Off	On
1	On	Off

ORDERING INFORMATION		
Temperature Range	Package	Part Number
- 40 °C to 85 °C	MSOP-10	DG2537DQ-T1-GE3
	MSOP-10	DG2538DQ-T1-GE3
	MSOP-10	DG2539DQ-T1-GE3

ABSOLUTE MAXIMUM RATINGS

Parameter	Limit	Unit
Referenced V+ to GND	- 0.3 to 6	V
IN, COM, NC, NO ^a	- 0.3 to (V+ + 0.3)	
Continuous Current (Any Terminal)	± 50	mA
Peak Current (Pulsed at 1 ms, 10 % duty cycle)	± 200	
Storage Temperature (D Suffix)	- 65 to 150	°C
Power Dissipation (Packages) ^b	MSOP-10 ^c	mW

Notes:

a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.

b. All leads welded or soldered to PC board.

c. Derate 4 mW/°C above 70 °C.

SPECIFICATIONS (V+ = 3 V, V- = 0 V)

Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 3 V, V- = 0 V, ± 10 %, V _{IN} = 0.4 V or 1.5 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range ^d	V _{NO} , V _{NC} V _{COM}		Full	0		V+	V
On-Resistance	R _{ON}	V+ = 2.7 V, V- = 0 V, V _{COM} = 0 V to V+, I _{NO} , I _{NC} = - 10 mA	Room Full		6.5	10	Ω
R _{ON} Flatness ^d	R _{ON} Flatness	V+ = 2.7 V, V- = 0 V, V _{COM} = 1.1 V to 1.6 V, I _{NO} , I _{NC} = - 10 mA	Room		0.4		
R _{ON} Match ^d	R _{ON} Match	V+ = 2.7 V, V- = 0 V, V _D = 1.1 V to 1.6 V, I _D = - 10 mA	Room Full		0.3	0.9	
Switch Off Leakage Current	I _{NO(off)} I _{NC(off)}	V+ = 3.3 V, V- = 0 V, V _{NO} , V _{NC} = 1 V/3 V, V _{COM} = 3 V/1 V	Room Full	- 0.25 - 0.35		0.25 0.35	nA
	I _{COM(off)}		Room Full	- 0.25 - 0.35		0.25 0.35	
Channel-On Leakage Current	I _{COM(on)}	V+ = 3.3 V, V- = 0 V, V _{NO} , V _{NC} = V _{COM} = 1 V/3 V	Room Full	- 0.25 - 0.35		0.25 0.35	
Digital Control							
Input High Voltage	V _{INH}		Full	2			V
Input Low Voltage	V _{INL}		Full			0.4	
Input Capacitance ^d	C _{in}	f = 1 MHz	Full		2.4		pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	- 1		1	μA
Dynamic Characteristics							
Turn-On Time	t _{ON}	V _{NO} or V _{NC} = 2 V, R _L = 300 Ω, C _L = 35 pF, figures 1 and 2	Room Full		16	55	ns
Turn-Off Time	t _{OFF}		Room Full		7	40	
Charge Injection ^d	Q _{INJ}	C _L = 1 nF, V _{GEN} = 0 V, R _{GEN} = 0 Ω, figure 3	Room		1.8		pC
Bandwidth ^d	BW	V+ = 3 V, R _L = 50 Ω, C _L = 5 pF, - 3dB	Room		319		MHz
Off-Isolation ^d	OIRR	R _L = 50 Ω, C _L = 5 pF, f = 1 MHz	Room		- 67		dB
Crosstalk ^d	X _{TALK}		Room		- 92		
Off-Isolation ^d	OIRR	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz	Room		- 47		
Crosstalk ^d	X _{TALK}		Room		- 90		
Source-Off Capacitance ^d	C _{NC/NO(off)}	V _{IN} = 0 or V+, f = 1 MHz	Room		8		pF
Drain-Off Capacitance ^d	C _{COM(off)}		Room		9		
Channel-On Capacitance ^d	C _{ON}		Room		22		
Power Supply							
Power Supply Current	I+	V _{IN} = 0 or V+, V+ = 3.3 V				1	μA



SPECIFICATIONS (V+ = 5 V, V- = 0 V)							
Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = 5 V, V- = 0 V, ± 10 %, VIN = 0.8 V or 2.4 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range ^d	VNO, VNC VCOM		Full	0		V+	V
On-Resistance	RON	V+ = 4.5 V, V- = 0 V, VCOM = 0 V to V+, INO, INC = 10 mA	Room Full		2.5	4.5 5	Ω
RON Flatness ^d	RON Flatness	V+ = 4.5 V, V- = 0 V, VCOM = 1.3 V to 3 V, INO, INC = 10 mA	Room		0.75	1.5	
RON Match ^d	RON Match	V+ = 4.5 V, V- = 0 V, ID = 10 mA, VCOM = 1.3 V to 3 V	Room		0.2	0.9	
Switch Off Leakage Current	INO(off) INC(off)	V+ = 5.5 V, V- = 0 V, VNO, VNC = 1 V/4.5 V, VCOM = 4.5 V/1 V	Room Full	- 0.25 - 0.35		0.25 0.35	nA
	ICOM(off)		Room Full	- 0.25 - 0.35		0.25 0.35	
Channel-On Leakage Current	ICOM(on)	V+ = 5.5 V, V- = 0 V, VNO, VNC = VCOM = 1 V/4.5 V	Room Full	- 0.25 - 0.35		0.25 0.35	
Digital Control							
Input High Voltage	VINH		Full	2.4			V
Input Low Voltage	VINL		Full			0.8	
Input Capacitance	Cin	f = 1 MHz	Full		2.2		pF
Input Current	IINL or IINH	VIN = 0 or V+	Full	- 0.1	0.005	0.1	μA
Dynamic Characteristics							
Turn-On Time ^d	tON	VNO or VNC = 3 V, RL = 300 Ω, CL = 35 pF, figures 1 and 2	Room Full		17	30 40	ns
Turn-Off Time ^d	tOFF		Room Full		9	35	
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω, figure 3	Room		2.2		pC
Bandwidth ^d	BW	V+ = 5 V, RL = 50 Ω, CL = 5 pF, - 3 dB	Room		366		MHz
Off-Isolation ^d	OIRR	RL = 50 Ω, CL = 5 pF, f = 1 MHz	Room		- 67		dB
Crosstalk ^d	XTALK		Room		- 90		
Off-Isolation ^d	OIRR	RL = 50 Ω, CL = 5 pF, f = 10 MHz	Room		- 47		
Crosstalk ^d	XTALK		Room		- 90		
Source-Off Capacitance ^d	CNC/NO(off)	VIN = 0 or V+, f = 1 MHz	Room		8		pF
Drain-Off Capacitance ^d	CCOM(off)		Room		9		
Channel-On Capacitance ^d	CON		Room		22		
Power Supply							
Power Supply Range	V+			2.6		4.3	V
Power Supply Current	I+	VIN = 0 or V+, V+ = 5.5 V	Full			2	μA

SPECIFICATIONS (V+ = + 2.5 V, V- = - 2.5 V)							
Parameter	Symbol	Test Conditions Otherwise Unless Specified V+ = + 2.5 V, V- = - 2.5 V, ± 10 %, VIN = 0.8 V or 2.4 V ^e	Temp. ^a	Limits - 40 °C to 85 °C			Unit
				Min. ^b	Typ. ^c	Max. ^b	
Analog Switch							
Analog Signal Range	VNO, VNC VCOM		Full	V-		V+	V
On-Resistance	RON	V+ = + 2.25 V, V- = - 2.25 V, VCOM = V- to V+, INO, INC = 10 mA	Room Full		3.6	4.5 5	Ω
RON Flatness	RON Flatness	V+ = + 2.25 V, V- = - 2.25 V, VCOM = ± 1.2 V, 0 V, INO, INC = 10 mA	Room		0.7	1.5	
RON Match	RON Match	V+ = + 2.25 V, V- = - 2.25 V, VCOM = ± 1.4 V, INO, INC = 10 mA	Room		0.2	0.9	
Switch Off Leakage Current	INO(off) INC(off)	V+ = + 2.75 V, V- = - 2.75 V, VS = ± 2.5 V, VD = ± 2.5 V	Room Full	- 0.25 - 0.35		0.25 0.35	nA
	ICOM(off)		Room Full	- 0.25 - 0.35		0.25 0.35	
Switch on Leakage	ICOM(on)	V+ = + 2.75 V, V- = - 2.25 V, VS = VD = ± 2.5 V	Room Full	- 0.25 - 0.35		0.25 0.35	
Digital Control							
Input High Voltage	VINH		Full	2.4			V
Input Low Voltage	VINL		Full			0.8	
Input Capacitance	Cin	f = 1 MHz	Full		2.2		pF
Input Current	INIL or INIH	VIN = 0 or V+	Full	- 0.1		0.1	μA
Dynamic Characteristics							
Turn-On Time ^d	tON	VNO or VNC = 2 V, RL = 300 Ω, CL = 35 pF	Room Full			35 40	ns
Turn-Off Time ^d	tOFF		Room Full			20 25	
Charge Injection ^d	QINJ	CL = 1 nF, VGEN = 0 V, RGEN = 0 Ω	Room		2.2		pC
Bandwidth ^d	BW	V+ = + 2.5 V, V- = - 2.5 V, RL = 50 Ω, CL = 5 pF, - 3dB	Room		366		MHz
Off-Isolation ^d	OIRR	V+ = + 2.5 V, V- = - 2.5 V, RL = 50 Ω, CL = 5 pF, - 3dB, f = 1 MHz	Room		- 67		dB
Crosstalk ^d	XTALK		Room		- 90		
Off-Isolation ^d	OIRR	V+ = + 2.5 V, V- = - 2.5 V, RL = 50 Ω, CL = 5 pF, - 3dB, f = 10 MHz	Room		- 47		
Crosstalk ^d	XTALK		Room		- 90		
Source-Off Capacitance ^d	CNC/NO(off)	VIN = 0 or V+, f = 1 MHz	Room		6		pF
Drain-Off Capacitance ^d	CCOM(off)		Room		12		
Channel-On Capacitance ^d	CON		Room		24		
Power Supply							
Power Supply Range	V+			1.25		2.75	V
Power Supply	I+	VIN = 0 or V+, V+ = 2.5 V				2	μA

Notes:

a. Room = 25 °C, Full = as determined by the operating suffix.

b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.

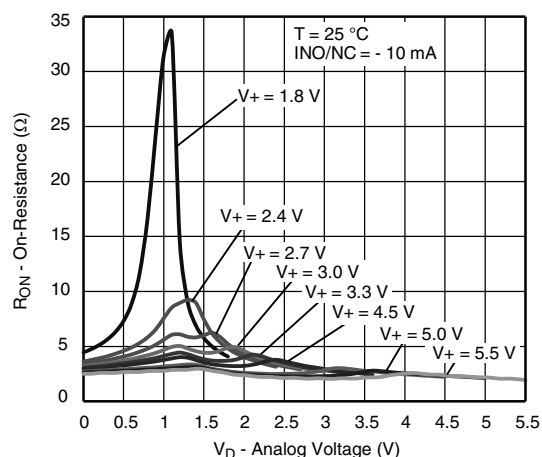
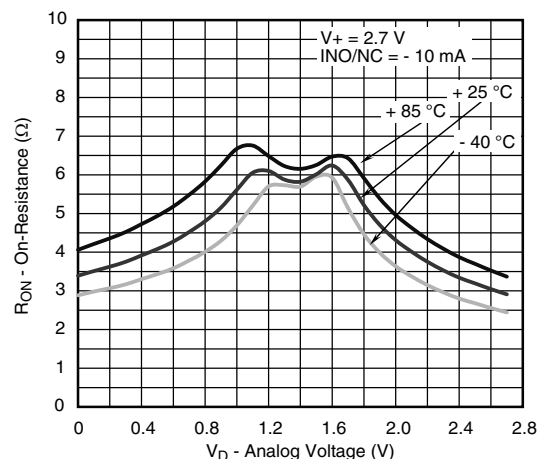
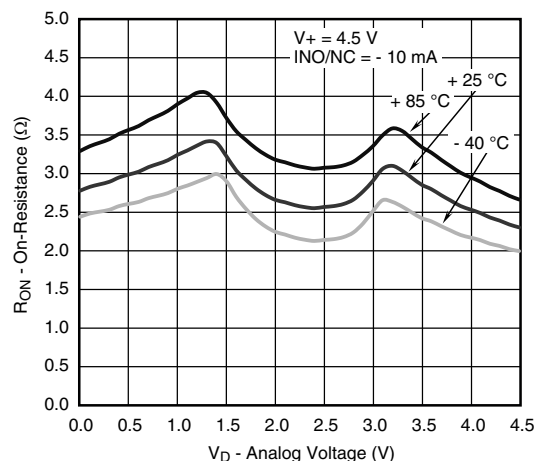
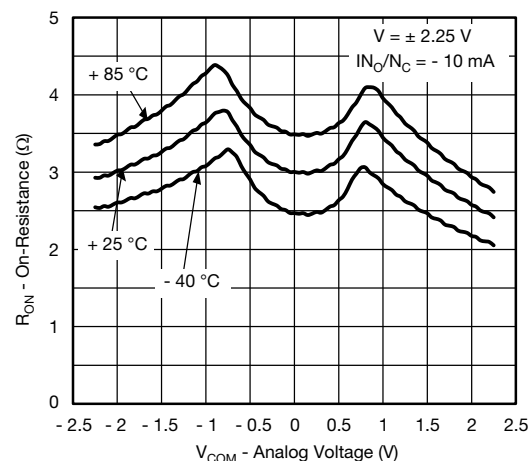
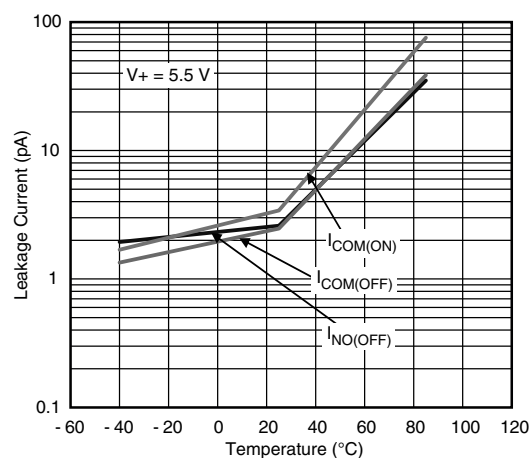
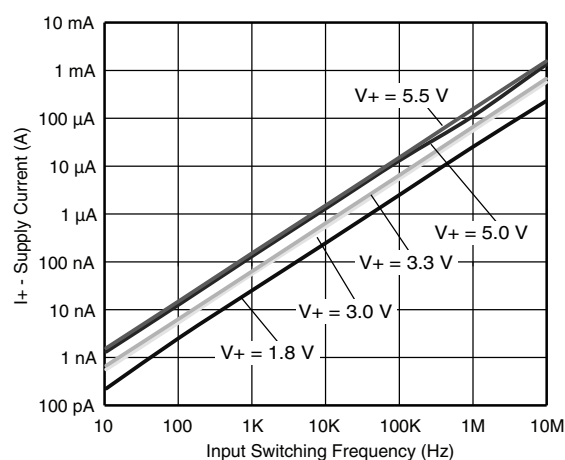
c. Typical values are for design aid only, not guaranteed nor subject to production testing.

d. Guarantee by design, nor subjected to production test.

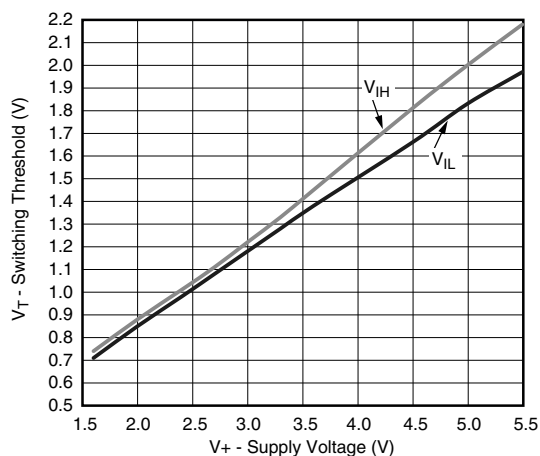
e. V_{IN} = input voltage to perform proper function.

f. Not production tested.

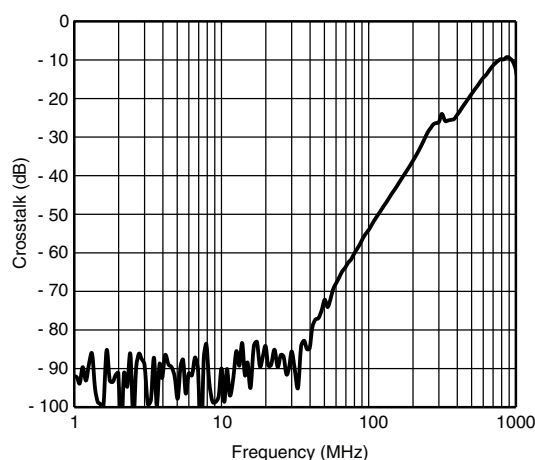
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

 R_{ON} vs. V_D and Single Supply Voltage

 R_{ON} vs. Analog Voltage and Temperature

 R_{ON} vs. Analog Voltage and Temperature

 R_{ON} vs. Analog Voltage and Temperature

Leakage Current vs. Temperature

Supply Current vs. Input Switching Frequency

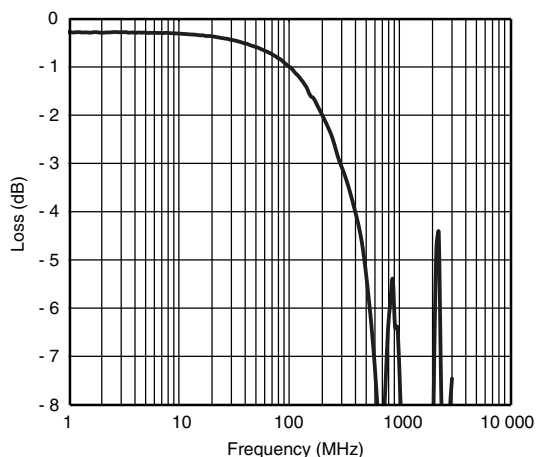
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)



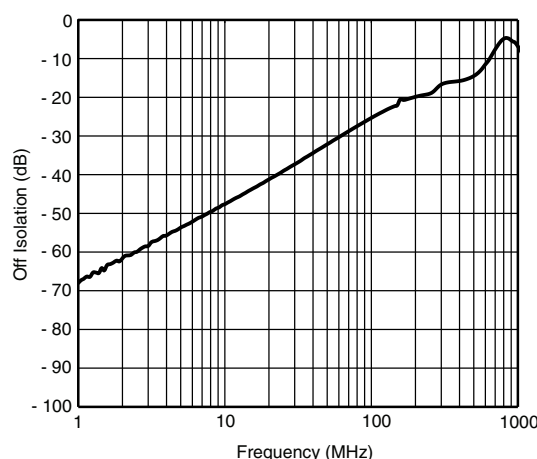
Switching Threshold vs. Supply Voltage



Crosstalk vs. Frequency



Insertion Loss vs. Frequency



Off Isolation vs. Frequency

TEST CIRCUITS

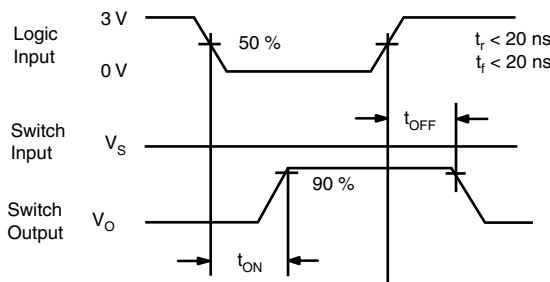
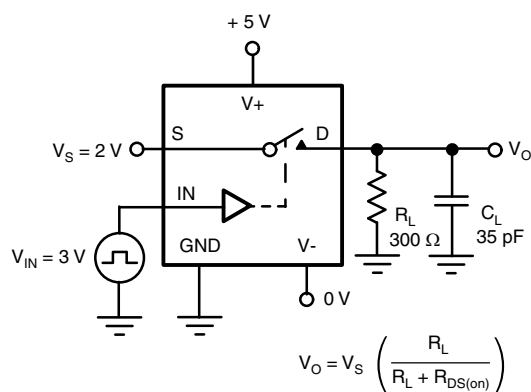
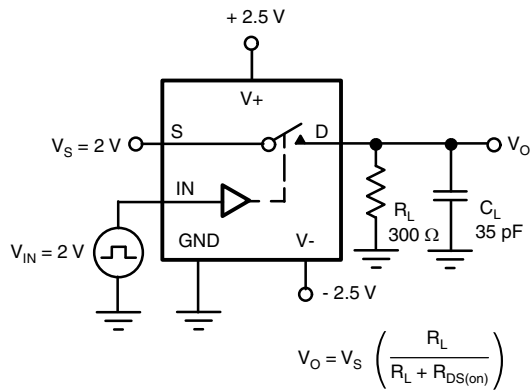
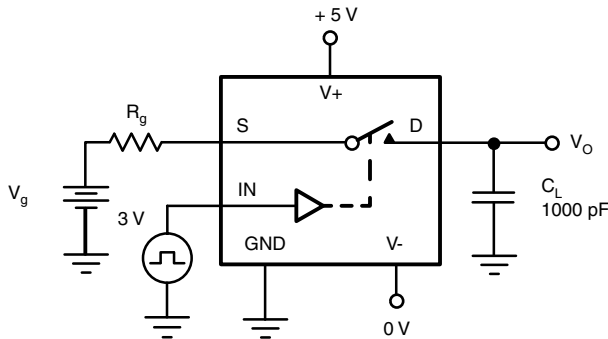
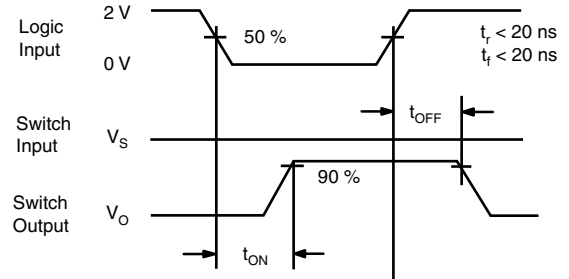
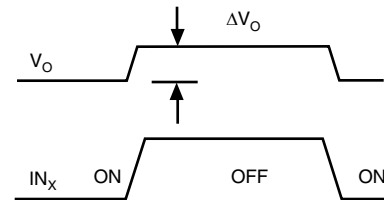
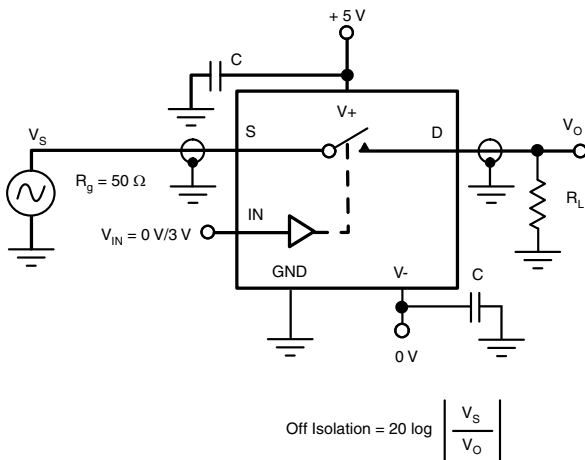
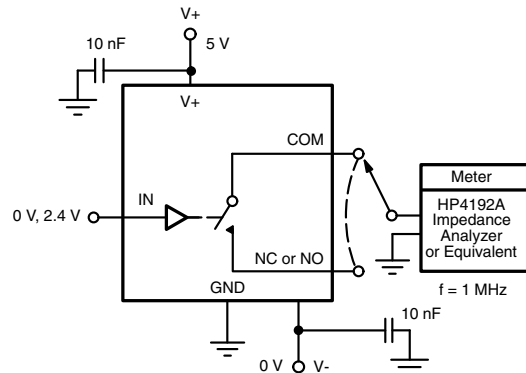


Figure 1. Single Supply Switching Time

TEST CIRCUITS

Figure 2. Dual Supply Switching Time

Figure 3. Charge Injection


ΔV_O = measured voltage error due to charge injection
The charge injection in coulombs is $\Delta Q = C_L \times \Delta V_O$


Figure 4. Off-Isolation

Figure 5. Channel Off/On Capacitance

TEST CIRCUITS

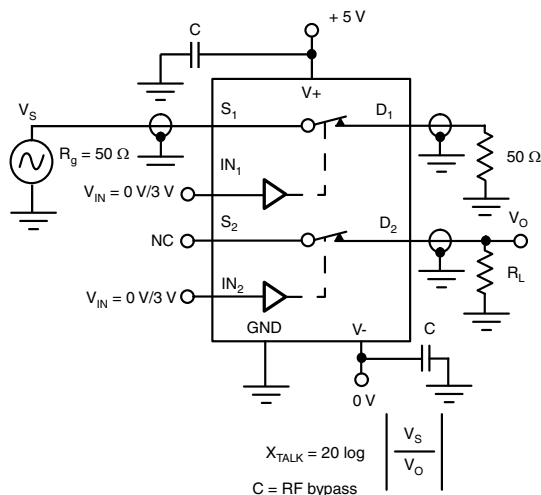


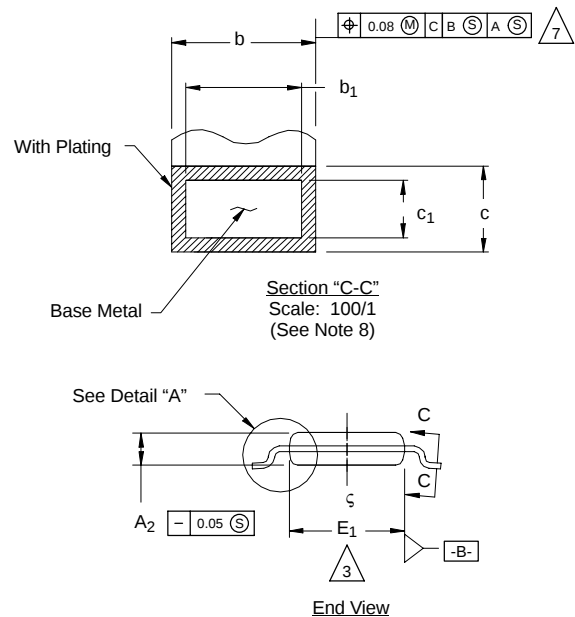
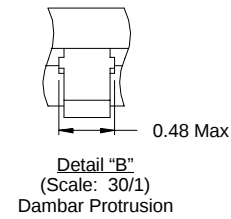
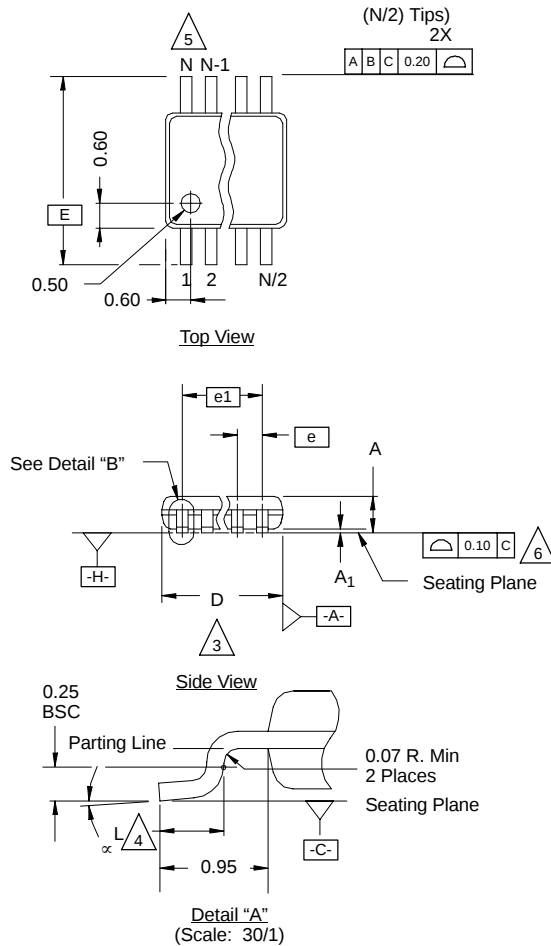
Figure 6. Channel to Channel Crosstalk

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63370.



MSOP: 10-LEADS

JEDEC Part Number: MO-187, (Variation AA and BA)



NOTES:

- Die thickness allowable is 0.203 ± 0.0127 .
- Dimensioning and tolerances per ANSI.Y14.5M-1994.
- Dimensions "D" and "E₁" do not include mold flash or protrusions, and are measured at Datum plane $\square H$, mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimension is the length of terminal for soldering to a substrate.
- Terminal positions are shown for reference only.
- Formed leads shall be planar with respect to one another within 0.10 mm at seating plane.
- The lead width dimension does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the lead width dimension at maximum material condition. Dambar cannot be located on the lower radius or the lead foot. Minimum space between protrusions and an adjacent lead to be 0.14 mm. See detail "B" and Section "C-C".
- Section "C-C" to be determined at 0.10 mm to 0.25 mm from the lead tip.
- Controlling dimension: millimeters.
- This part is compliant with JEDEC registration MO-187, variation AA and BA.
- Datums $\square A$ and $\square B$ to be determined Datum plane $\square H$.
- Exposed pad area in bottom side is the same as the leadframe pad size.

N = 10L

Dim	MILLIMETERS			Note
	Min	Nom	Max	
A	-	-	1.10	
A ₁	0.05	0.10	0.15	
A ₂	0.75	0.85	0.95	
b	0.17	-	0.27	8
b ₁	0.17	0.20	0.23	8
c	0.13	-	0.23	
c ₁	0.13	0.15	0.18	
D	3.00 BSC			3
E	4.90 BSC			
E ₁	2.90	3.00	3.10	3
e	0.50 BSC			
e ₁	2.00 BSC			
L	0.40	0.55	0.70	4
N	10			5
α	0°	4°	6°	

ECN: T-02080—Rev. C, 15-Jul-02
DWG: 5867



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Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Данный компонент на территории Российской Федерации

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Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9